

SANYO Semiconductors

DATA SHEET

N-Channel Silicon MOSFET ECH8612 — General-Purpose Switching Device **Applications**

Features

- · Low ON-resistance.
- · Best suited for load switches.
- 1.8V drive.
- · Composite type, facilitating high-density mounting.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		20	V
Gate-to-Source Voltage	VGSS		±8	V
Drain Current (DC)	۱D		7	А
Drain Current (Pulse)	IDP	PW≤10µs, duty cycle≤1%	40	А
Allowable Power Dissipation	PD	Mounted on a ceramic board (900mm ² X0.8mm) 1unit	1.3	W
Total Dissipation	PT	Mounted on a ceramic board (900mm ² X0.8mm)	1.5	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			11-14
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	20			V
Zero-Gate Voltage Drain Current	IDSS	VDS=20V, VGS=0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±6.4V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	V _{GS} (off)	V _{DS} =10V, I _D =1mA	0.4		1.2	V
Forward Transfer Admittance	yfs	VDS=10V, ID=3.5A	6.6	11		S
Static Drain-to-Source On-State Resistance	R _{DS} (on)1	ID=3A, VGS=4.5V		18	24	mΩ
	RDS(on)2	ID=1.5A, VGS=2.5V		25	36	mΩ
	RDS(on)3	ID=0.5A, VGS=1.8V		35	52	mΩ
Input Capacitance	Ciss	V _{DS} =10V, f=1MHz		920		pF
Output Capacitance	Coss	VDS=10V, f=1MHz		150		pF
Reverse Transfer Capacitance	Crss	V _{DS} =10V, f=1MHz		120		pF

Marking : FE

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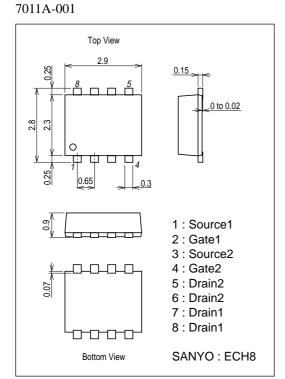
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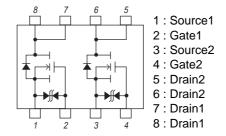
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Turn-ON Delay Time	td(on)	See specified Test Circuit.		14		ns
Rise Time	tr	See specified Test Circuit.		170		ns
Turn-OFF Delay Time	td(off)	See specified Test Circuit.		100		ns
Fall Time	tf	See specified Test Circuit.		98		ns
Total Gate Charge	Qg	V _{DS} =10V, V _{GS} =4.5V, I _D =7A		12		nC
Gate-to-Source Charge	Qgs	VDS=10V, VGS=4.5V, ID=7A		1.3		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =10V, V _{GS} =4.5V, I _D =7A		3.7		nC
Diode Forward Voltage	VSD	IS=7A, VGS=0V		0.83	1.2	V

Package Dimensions

unit : mm

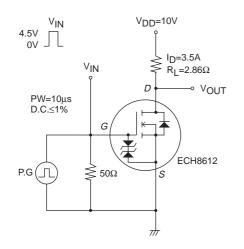


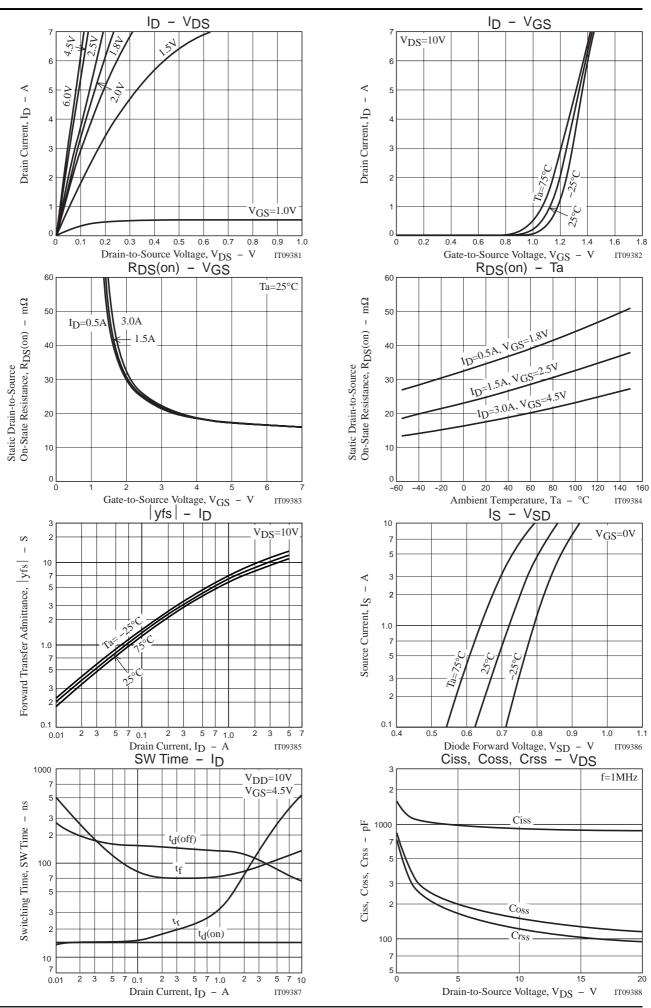
Electrical Connection

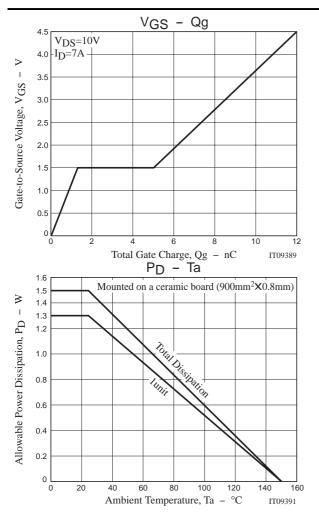


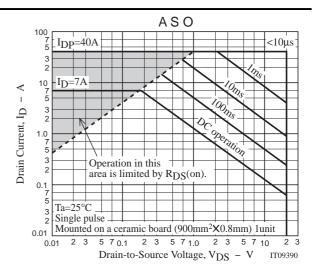
Top view

Switching Time Test Circuit









Note on usage : Since the ECH8612 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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